Programmable Hi-performance IR Pre-heating Plate Model IHP400



designed for bottom pre-heating of multilayer & high heat sink Printed Circuit Boards

The IHP400 Pre-heating Plate enhances the effectiveness of the IMFS600 Rework Systems. It provides bottom heating to the PCB under repair, therefore minimizing the risk of thermal damage to expensive SMD ICs and warping of expensive multilayer PCBs. Additionally it also speeds up the rework/repair process.



- High quality, long life IR Ceramic Heating Elements ensure fast and even pre-heating with high efficiency
- in-built temperature measurement with thermocouple allows continuous monitoring of PCB temperature
- Pre-set temperature is achieved accurately and remains stable due to closed loop PID control design.
- TFT LCD display for accurate temperature and other parameters
- Fast and convenient in-built digital temperature calibration

Today's electronics design has higher density of expensive devices on the multilayer PCBs which inherently require gentle pre-heating of PCBs to avoid thermal damaging of expensive SMD ICs, and also must avoid

If pre-heating is not used, it can lead to pad lifting, delamination, warping

and burning of expensive PCBs & large SMD ICs during rework/repair. Beside these visible defects, the invisible defects like internal layer

To avoid above failures, PCBs will normally need even pre-heating around 120°C on top side while reworking. The Pre-heater model IHP-400 serves this purpose. PCBs are heated evenly and gently from bottom side for

Three channel temperature design for easy and fast temperature switching

Specifications:

- Heating Power
- Heating Area Heating Source

warping of PCBs.

- : 400 Watt : 130 x 130mm
- : IR Ceramic Heater
- Temperature Range

Why bottom Preheating is recommended ?

cracking etc. will also result if pre-heating is not used.

- : 50°C ~ 500°C
- Temperature Stability
- Temperature Sensor
- : K-type Thermocouple Measurement Range
 - : ±5°C

: ±1°C

- : 0~600°C

89

Thermometer Accuracy



PCB warping/burning possibility without pre-heating



Safe reworking of SMD ICs using bottom Preheater

safe reworking of SMD ICs.

on-site services can be provided at extra charges if pre-paid by customer in advance

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It excludes consumable parts as Heating Element, Sensor etc. and any mechanically damaged parts. While the information contained herein in, has been carefully compiled to the best of our knowledge, nothing is intended as representation and warranty on our part; and no statement shall be construed as recommendation to infringe any of existing patents. We accept no liability of whatsoever for any faults and errors in the information contained herein. Contents of this catalogue and specifications of the products, are subject to change without notice due to continuous improvements.

Warranty is 12 months from the date of invoice.

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eliable & caring since 1976

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Description of Keys

KEYS	Descriptions/Function
+	1. In main interface press to switch between CH1, CH2 & CH3 2. In setting interface: Return/Cancle
<u>ttt</u>	 Press in the main interface to turn ON/OFF In the setting interface: Advance/Save In the main interface, long press 2 sec to enter the setting interface
+ and -	Press at same time to enter temperature calibration interface
+	 In the main interface, press to increase the parameter value In the setting interface: Page up
-	 In the main interface, press to decrease the parameter value In the setting interface: Page down

T2 is Temperature Profile 2





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